



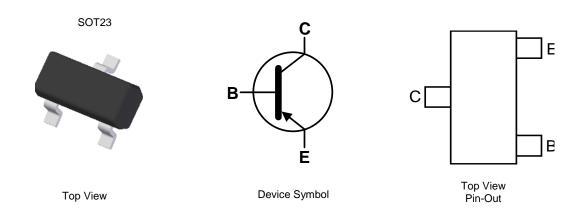
40V PNP SMALL SIGNAL TRANSISTOR IN SOT23

Features

- Epitaxial Planar Die Construction
- Ideal for Medium Power Amplification and Switching
- Complementary NPN Type: DIODES MMBT4401
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: SOT23
- Package Material: Molded Plastic "Green" Compound UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 ©3
- Weight: 0.008 grams (Approximate)



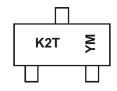
Ordering Information (Note 4)

| Part Number | Paakaga | Marking | Reel Size (inches) | Tape Width (mm) | Packing | |
|---------------|------------------------------------|---------|----------------------|---------------------|---------|---------|
| Fait Number | Package Marking Reel Size (inches) | | Reel Size (Illiches) | rape widin (ililii) | Qty. | Carrier |
| MMBT4403-7-F | SOT23 | K2T | 7 | 8 | 3,000 | Reel |
| MMBT4403-13-F | SOT23 | K2T | 13 | 8 | 10,000 | Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



K2T = Product Type Marking Code YM = Date Code Marking Y = Year (ex: K = 2023) M = Month (ex: 2 = February)

Date Code Kev

| Year | 2003 | | 2023 | 2024 | 2025 | 2026 | 2027 | 2028 | 2029 | 2030 | 2031 | 2032 |
|-------|------|-----|------|------|------|------|------|------|------|------|------|------|
| Code | Р | | K | L | М | N | 0 | Р | R | S | Т | U |
| | | | | | | | | | | | | |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |



Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|---|--------|-------|------|
| Collector-Base Voltage | Vсво | -40 | V |
| Collector-Emitter Voltage | Vceo | -40 | V |
| Emitter-Base Voltage | VEBO | -6 | V |
| Collector Current - Continuous (Note 7) | Ic | -600 | mA |

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

| Characteristic | | Symbol | Value | Unit | |
|---|----------|----------------------------------|-------------|-------|--|
| Collector Rower Discinction | (Note 5) | D- | 310 | mW | |
| Collector Power Dissipation | (Note 6) | PD | 350 | ITIVV | |
| Thermal Decistores, Junction to Ambient | (Note 5) | D | 403 | °C/W | |
| Thermal Resistance, Junction to Ambient | (Note 6) | Reja | 357 | °C/VV | |
| Thermal Resistance, Junction to Leads | (Note 7) | R ₀ JL | 350 | °C/W | |
| Thermal Resistance, Junction to Case | Rejc | 55 | °C/W | | |
| Operating and Storage Temperature Range | • | T _J ,T _{STG} | -55 to +150 | °C | |

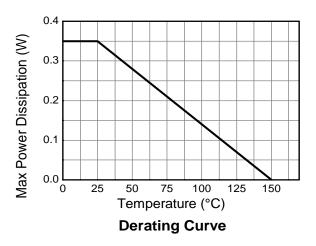
Notes:

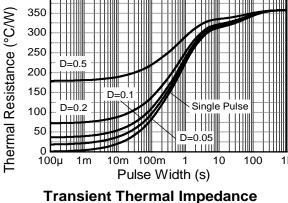
5. For the device mounted on minimum recommended pad layout FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.

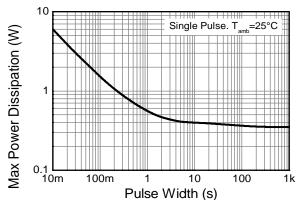
400

- 6. For the device mounted on 15mm x 15mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.
- 7. Thermal resistance from junction to solder-point (at the end of the collector lead).

Thermal Characteristics and Derating Information







Pulse Power Dissipation



Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

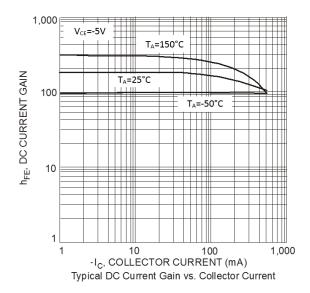
| Characteristic | Symbol | Min | Max | Unit | Test Condition | |
|--------------------------------------|---------------------------|------------------------------|-----------------|--------------------|---|--|
| OFF CHARACTERISTICS (Note 8) | | | | | | |
| Collector-Base Breakdown Voltage | BV _{CBO} | -40 | | V | $I_C = -100 \mu A$ | |
| Collector-Emitter Breakdown Voltage | BVceo | -40 | | V | Ic = -10mA | |
| Emitter-Base Breakdown Voltage | BVEBO | -6 | _ | V | $I_E = -100 \mu A$ | |
| Collector Cutoff Current | ICEX | | -100 | nA | $V_{CE} = -35V, V_{EB(off)} = -0.4V$ | |
| Base Cutoff Current | I _{BL} | _ | -100 | nA | $V_{CE} = -35V, V_{EB(off)} = -0.4V$ | |
| ON CHARACTERISTICS (Note 8) | | | | | | |
| DC Current Gain | hFE | 30 60 100 100 20 | 300 | | Ic = -100µA, Vce = -1V Ic = -1.0mA, Vce = -1V Ic = -10mA, Vce = -1V Ic = -150mA, Vce = -2V Ic = -500mA, Vce = -2V | |
| Collector-Emitter Saturation Voltage | VCE(sat) | | -0.40 -0.75 | V | $I_C = -150 \text{mA}, I_B = -15 \text{mA}$ $I_C = -500 \text{mA}, I_B = -50 \text{mA}$ | |
| Base-Emitter Saturation Voltage | V _{BE(sat)} | -0.75 — | -0.95 -1.30 | V | $I_C = -150$ mA, $I_B = -15$ mA $I_C = -500$ mA, $I_B = -50$ mA | |
| SMALL SIGNAL CHARACTERISTICS | | | | | | |
| Output Capacitance | Cobo | _ | 8.5 | pF | $V_{CB} = -10V$, $f = 1.0MHz$, $I_E = 0$ | |
| Input Capacitance | Cibo | _ | 30 | pF | $V_{EB} = -0.5V$, $f = 1.0MHz$, $I_{C} = 0$ | |
| Input Impedance | hie | 1.5 | 15 | kΩ | | |
| Voltage Feedback Ratio | h _{re} | 0.1 | 8.0 | x 10 ⁻⁴ | $V_{CE} = -10V, I_{C} = -1mA,$ | |
| Small Signal Current Gain | h _{fe} | 60 | 500 | _ | f = 1kHz | |
| Output Admittance | hoe | 1.0 | 100 | μS | | |
| Current Gain-Bandwidth Product | f⊤ | 200 | ١ | MHz | V _{CE} = -10V, I _C = -20mA, f = 100MHz | |
| SWITCHING CHARACTERISTICS | SWITCHING CHARACTERISTICS | | | | | |
| Delay Time | td | _ | 15 | ns | Vcc = -30V, Ic = -150mA, | |
| Rise Time | t _r | _ | 20 | ns | $V_{BE(off)} = -2V$, $I_{B1} = -15mA$ | |
| Storage Time | ts | _ | 225 | ns | Vcc = -30V, Ic = -150mA, | |
| Fall Time | t _f | <u> </u> | 30 | ns | $I_{B1} = -I_{B2} = -15mA$ | |

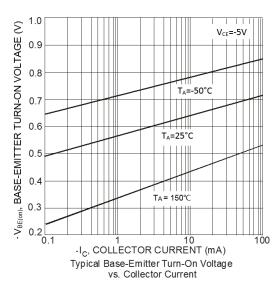
Note:

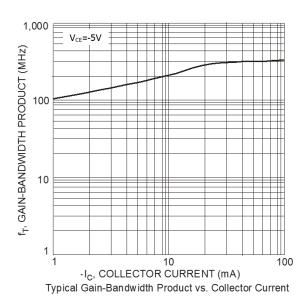
8. Short duration pulse test used to minimize self-heating effect.

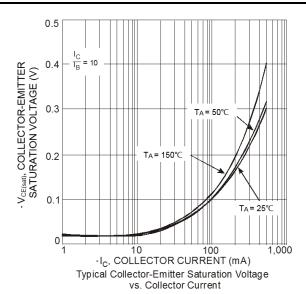


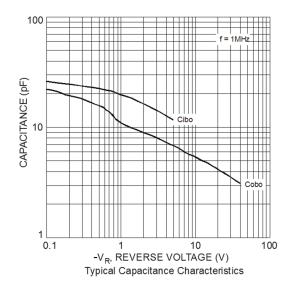
Typical Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

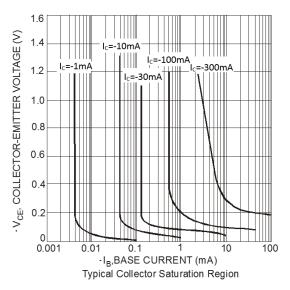










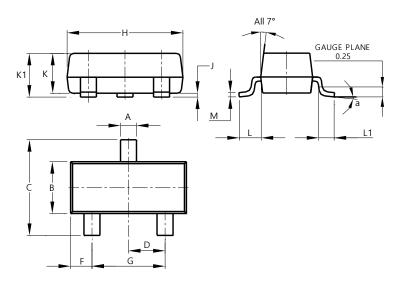




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23

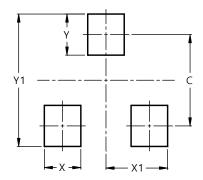


| SOT23 | | | | | | |
|-------|--------|---------|-------|--|--|--|
| Dim | Min | Max | Тур | | | |
| Α | 0.37 | 0.51 | 0.40 | | | |
| В | 1.20 | 1.40 | 1.30 | | | |
| C | 2.30 | 2.50 | 2.40 | | | |
| D | 0.89 | 1.03 | 0.915 | | | |
| F | 0.45 | 0.60 | 0.535 | | | |
| G | 1.78 | 2.05 | 1.83 | | | |
| Η | 2.80 | 3.00 | 2.90 | | | |
| 7 | 0.013 | 0.10 | 0.05 | | | |
| K | 0.890 | 1.00 | 0.975 | | | |
| K1 | 0.903 | 1.10 | 1.025 | | | |
| L | 0.45 | 0.61 | 0.55 | | | |
| L1 | 0.25 | 0.55 | 0.40 | | | |
| М | 0.085 | 0.150 | 0.110 | | | |
| а | 0° | 8° | | | | |
| All | Dimens | ions in | mm | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



| Dimensions | Value (in mm) |
|------------|---------------|
| С | 2.0 |
| Х | 0.8 |
| X1 | 1.35 |
| Υ | 0.9 |
| Y1 | 2.9 |



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